



60V N-CHANNEL ENHANCEMENT MODE MOSFET POWERDI®

Product Summary

V _{(BR)DSS}	R _{DS(ON)}	I _D T _A = +25°C
60V	$16m\Omega @ V_{GS} = 10V$	10.6 A
607	$24m\Omega @ V_{GS} = 4.5V$	8.7 A

Description

This MOSFET is designed to minimize the on-state resistance ($R_{DS(ON)}$) and maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Load Switch
- Adaptor Switch
- Notebook PC

Features

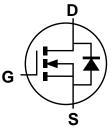
- Thermally Efficient Package-Cooler Running Applications
- High Conversion Efficiency
- Low RDS(ON) Minimizes On State Losses
- Low Input Capacitance
- Fast Switching Speed
- <1.1mm Package Profile Ideal for Thin Applications
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

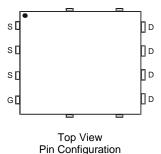
- Case: POWERDI5060-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Weight: 0.097 grams (Approximate)



Top View Bottom View



Internal Schematic



Ordering Information (Note 4)

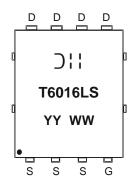
Part Number	Case	Packaging
DMT6016LPS-13	POWERDI5060-8	2,500 / Tape & Reel

Pin1

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



T6016LS = Product Type Marking Code
YYWW = Date Code Marking
YY = Last Digit of Year (ex: 14 = 2014)
WW = Week Code (01 to 53)



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic			Symbol	Value	Units
Drain-Source Voltage			V_{DSS}	60	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Dunin Courset (Note C) // 40)/	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	10.6 8.5	А
Continuous Drain Current (Note 6) V _{GS} = 10V	t < 10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	14.8 11.9	А
Pulsed Drain Current (10µs pulse, duty cycle = 1%)	I _{DM}	60	Α		
Maximum Continuous Body Diode Forward Current (Note 6)			I _S	2	Α
Avalanche Current (Note 7) L = 0.1mH			I _{AS}	15.3	Α
Avalanche Energy (Note 7) L = 0.1mH			E _{AS}	11.7	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Units
Total Power Dissipation (Note 5)		P_{D}	1.23	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	-	102	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	$R_{\theta JA}$	52	
Total Power Dissipation (Note 6)		P_{D}	2.7	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady state	-	49	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{ hetaJA}$	24	
Thermal Resistance, Junction to Case (Note 6)		$R_{ heta JC}$	4.8	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	_

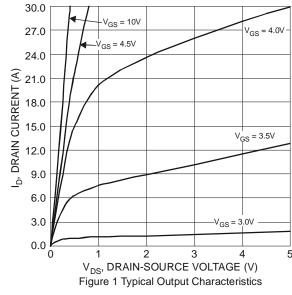
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

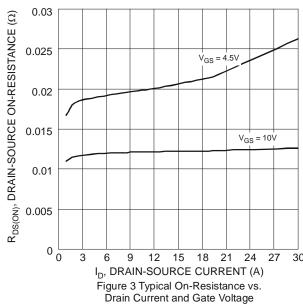
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV_{DSS}	60	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 48V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(th)}	1	_	2.5	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance		_	_	16	mΩ	$V_{GS} = 10V, I_D = 10A$	
Static Drain-Source On-Resistance	R _{DS} (ON)	_	_	24	11177	$V_{GS} = 4.5V, I_D = 6A$	
Diode Forward Voltage	V_{SD}	_	0.7	1.2	V	$V_{GS} = 0V$, $I_S = 1A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss		864	_		\/ 00\/ \/ 0\/	
Output Capacitance	Coss	_	282	_	pF	$V_{DS} = 30V$, $V_{GS} = 0V$, $f = 1MHz$	
Reverse Transfer Capacitance	C _{rss}	_	27	_			
Gate Resistance	R_{G}	_	1.3	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Q_g	_	8.4	_			
Total Gate Charge (V _{GS} = 10V)	Qg	_	17	_	nC	V _{DS} = 30V, I _D = 10A	
Gate-Source Charge	Q_{gs}	_	3.1	_	IIC	$V_{DS} = 30V, I_D = 10A$	
Gate-Drain Charge	Q _{gd}	_	4.3	_			
Turn-On Delay Time	t _{D(on)}	_	3.4	_			
Turn-On Rise Time	t _r	_	5.2	_		$V_{GS} = 10V, V_{DS} = 30V,$	
Turn-Off Delay Time	t _{D(off)}	_	13	_	ns	$R_G = 6\Omega$, $I_D = 10A$	
Turn-Off Fall Time	t _f	_	7	_			
Reverse Recovery Time	t _{rr}	_	22	_	ns	1 400 15/15 4000/	
Reverse Recovery Charge	Q _{rr}	_	11	_	nC	I _F = 10A, di/dt = 100A/μs	

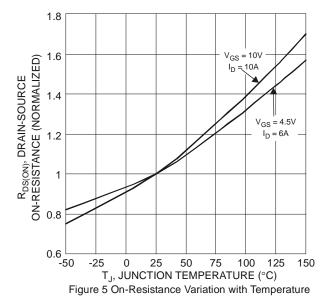
Notes:

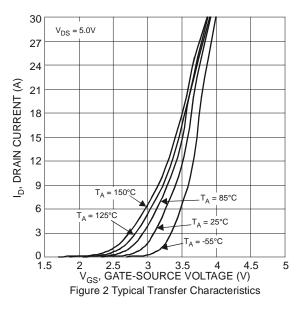
- 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
 7. I_{AS} and E_{AS} rating are based on low frequency and duty cycles to keep T_J = +25°C.
 8. Short duration pulse test used to minimize self-heating effect.
 9. Guaranteed by design. Not subject to product testing.

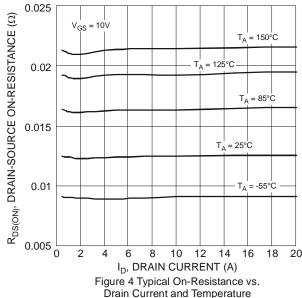












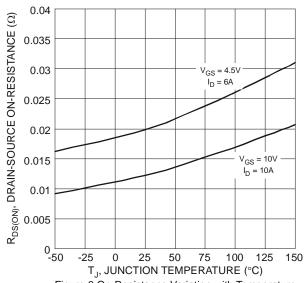


Figure 6 On-Resistance Variation with Temperature



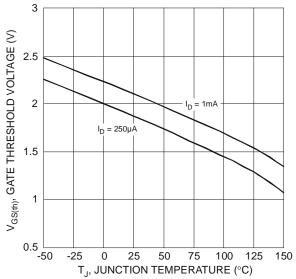


Figure 7 Gate Threshold Variation vs. Ambient Temperature

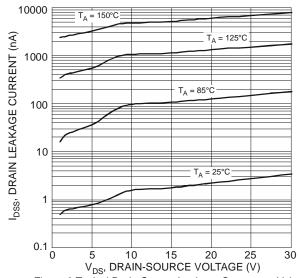
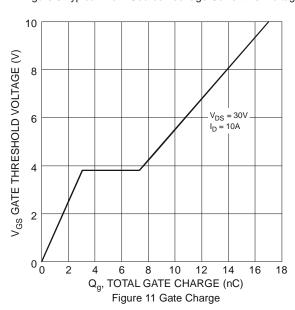
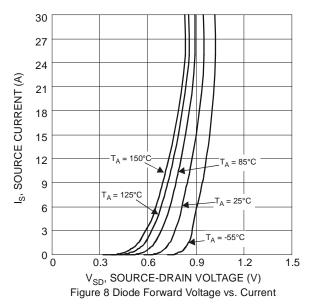
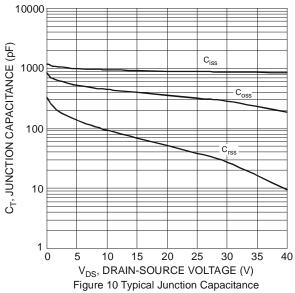
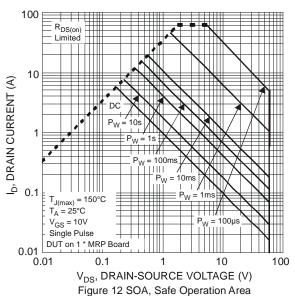


Figure 9 Typical Drain-Source Leakage Current vs. Voltage

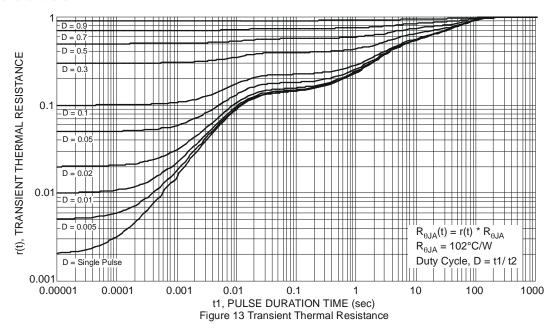






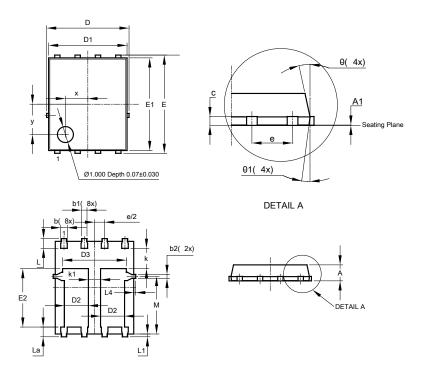






Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

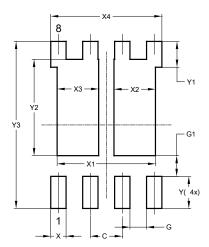


PowerDI5060-8						
Dim	Min	Max	Тур			
Α	0.90	1.10	1.00			
A1	0	0.05	0.02			
b	0.33	0.51	0.41			
b1	0.300	0.366	0.333			
b2	0.20	0.35	0.25			
С	0.23	0.33	0.277			
D	5	.15 BS0				
D1	4.85	4.95	4.90			
D2	1.40	1.60	1.50			
D3			3.98			
Е	6.15 BSC					
E1	5.75	5.85	5.80			
E2	3.56	3.76	3.66			
е	1	.27BSC				
k			1.27			
k1	0.56	-	-			
L	0.51	0.71	0.61			
La	0.51	0.71	0.61			
L1	0.05	0.20	0.175			
L4	-	-	0.125			
M	3.50	3.71	3.605			
X	-	-	1.400			
У	-	-	1.900			
θ	10°	12°	11°			
θ1	6°	8°	7°			
All Dimensions in mm						



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)		
С	1.270		
G	0.660		
G1	0.820		
X	0.610		
X1	3.910		
X2	1.650		
Х3	1.650		
X4	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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